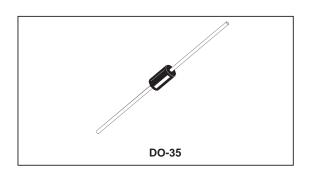


SMALL SIGNAL SCHOTTKY DIODE

DESCRIPTION

Metal to silicon junction diode featuring high breakdown, low turn-on voltage and ultrafast switching. Primarly intended for high level UHF/VHF detection and pulse application with broad dynamic range. Matched batches are available on request



ABSOLUTE RATINGS (limiting values)

| Symbol | Parameter | Value | Unit |
|------------------------------------|---|----------------------------|------|
| V_{RRM} | Repetitive Peak Reverse Voltage | 70 | V |
| l _F | Forward Continuous Current* | 15 | mA |
| P _{tot} | Power Dissipation* | 430 | mW |
| T _{stg} T _j | Storage and Junction Temperature Range | - 65 to 200 - 65 to 200 | °C |
| T∟ | Maximum Lead Temperature for Soldering duri from Case | 230 | °C |

THERMAL RESISTANCE

| Symbol | Test Conditions | Value | Unit |
|---------------|-------------------|-------|------|
| $R_{th(j-a)}$ | Junction-ambient* | 400 | °C/W |

ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

| Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|--------------------|---|------|------|------|------|
| V_{BR} | $T_{amb} = 25^{\circ}C$ $I_R = 10\mu A$ | 70 | | | V |
| V _F * * | $T_{amb} = 25^{\circ}C$ $I_F = 1mA$ | | | 0.41 | V |
| | $T_{amb} = 25^{\circ}C$ $I_F = 15mA$ | | | 1 | |
| I _R * * | T _{amb} = 25°C | | | 0.2 | μΑ |

DYNAMIC CHARACTERISTICS

| Symbol | Test Conditions | | | Min. | Тур. | Max. | Unit |
|--------|-------------------------|-------------|-----------------|------|------|------|------|
| С | T _{amb} = 25°C | $V_R = 0V$ | f = 1MHz | | | 2 | pF |
| τ | T _{amb} = 25°C | $I_F = 5mA$ | Krakauer Method | | | 100 | ps |

* On infinite heatsink with 4mm lead length
** Pulse test: $t_p \le 300 \mu s \ \delta < 2\%$.
Matched batches available on request. Test conditions (forward voltage and/or capacitance) according to customer specification.

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Fig. 1: Forward current versus forward voltage at low level (typical values).

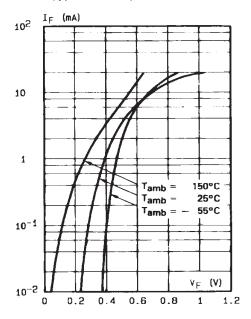


Fig. 2: Capacitance C versus reverse applied voltage $V_{\mbox{\tiny R}}$ (typical values).

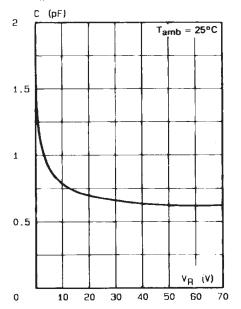


Fig. 3: Reverse current versus ambient temperature.

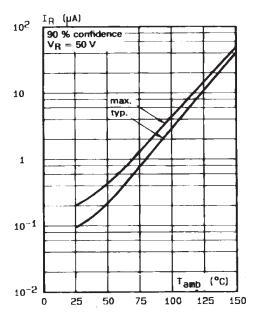
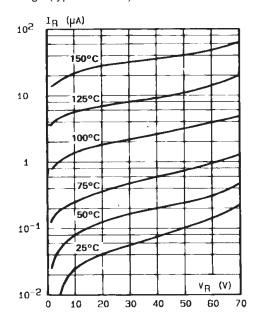


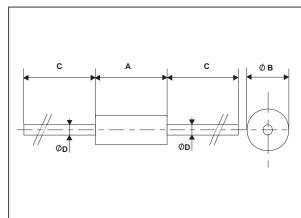
Fig. 4: Reverse current versus continuous reverse voltage (typical values).



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PACKAGE MECHANICAL DATA

DO-35



| REF. | DIMENSIONS | | | |
|------|-------------|-------|-------|-------|
| | Millimeters | | Inc | hes |
| | Min. | Max. | Min. | Max. |
| А | 3.05 | 4.50 | 0.120 | 0.177 |
| В | 1.53 | 2.00 | 0.060 | 0.079 |
| С | 28.00 | | 1.102 | |
| D | 0.458 | 0.558 | 0.018 | 0.022 |

Cooling method : by convection and conduction Marking: clear, ring at cathode end. Weight: 0.15g

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